

Features

- Generates clock signals at power-up per user defined custom OTP (One Time Programmable) configuration
- Dynamically configurable via SPI/I2C interface and volatile configuration registers
- Two independently programmable clock generators output any clock rate from 1 kHz to 750 MHz
- Precision clock generators output clocks with jitter below 0.7 ps RMS for 10 G PHYs
- Operates from a single crystal resonator, clock oscillator or voltage controlled oscillator
- Supports programmable frequency offsets for clock margining; or for use as a digitally controlled oscillator
- Eight LVPECL outputs; max rate 750 MHz
- Four LVCMOS outputs; max rate 177.5 MHz

Ordering Information

ZL30236GGG	100 Pin LBG	11mmx11mm	Trays
ZL30236GGG2	100 Pin LBG*	11mmx11mm	Trays

*Pb Free Tin/Silver/Copper
-40°C to +85°C

Applications

- Timing for NPUs, FPGAs, Ethernet switches and PCIe switches
- Timing for 10 Gigabit CDRs, Rapid-IO, PCIe, Serial MII, Star Fabric, Fibre Channel, XAUI
- Processor clock, Processor bus clock, SDRAM clock, DDR clock

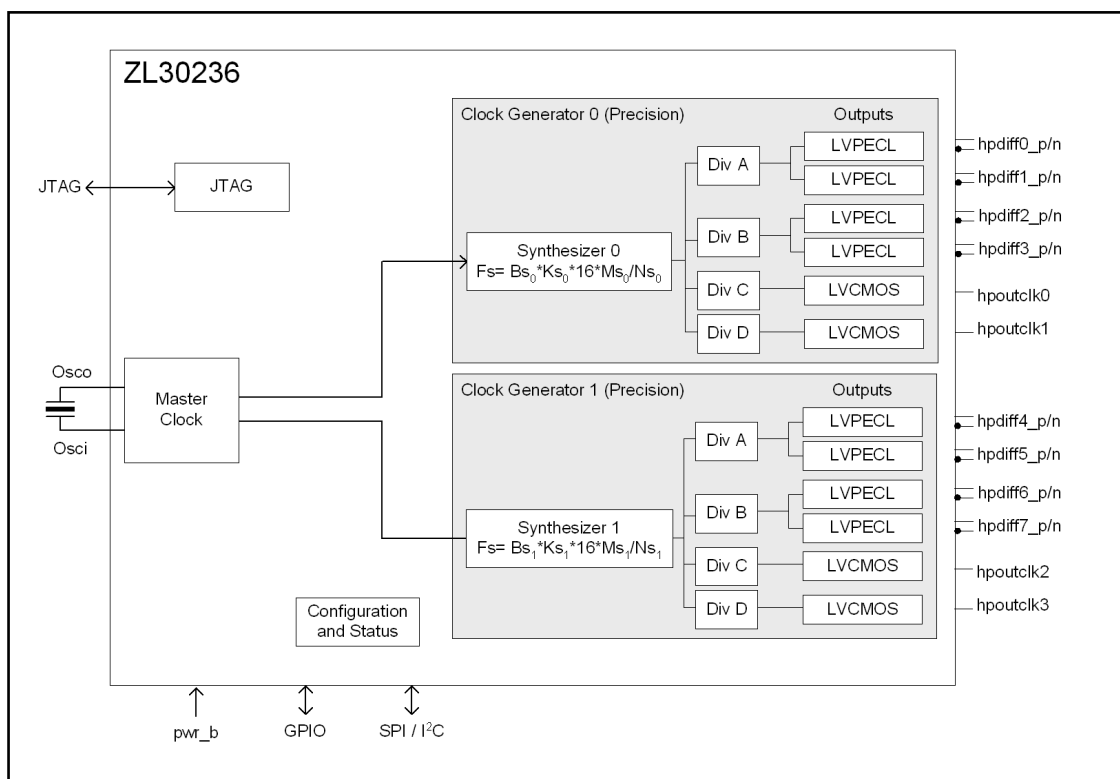
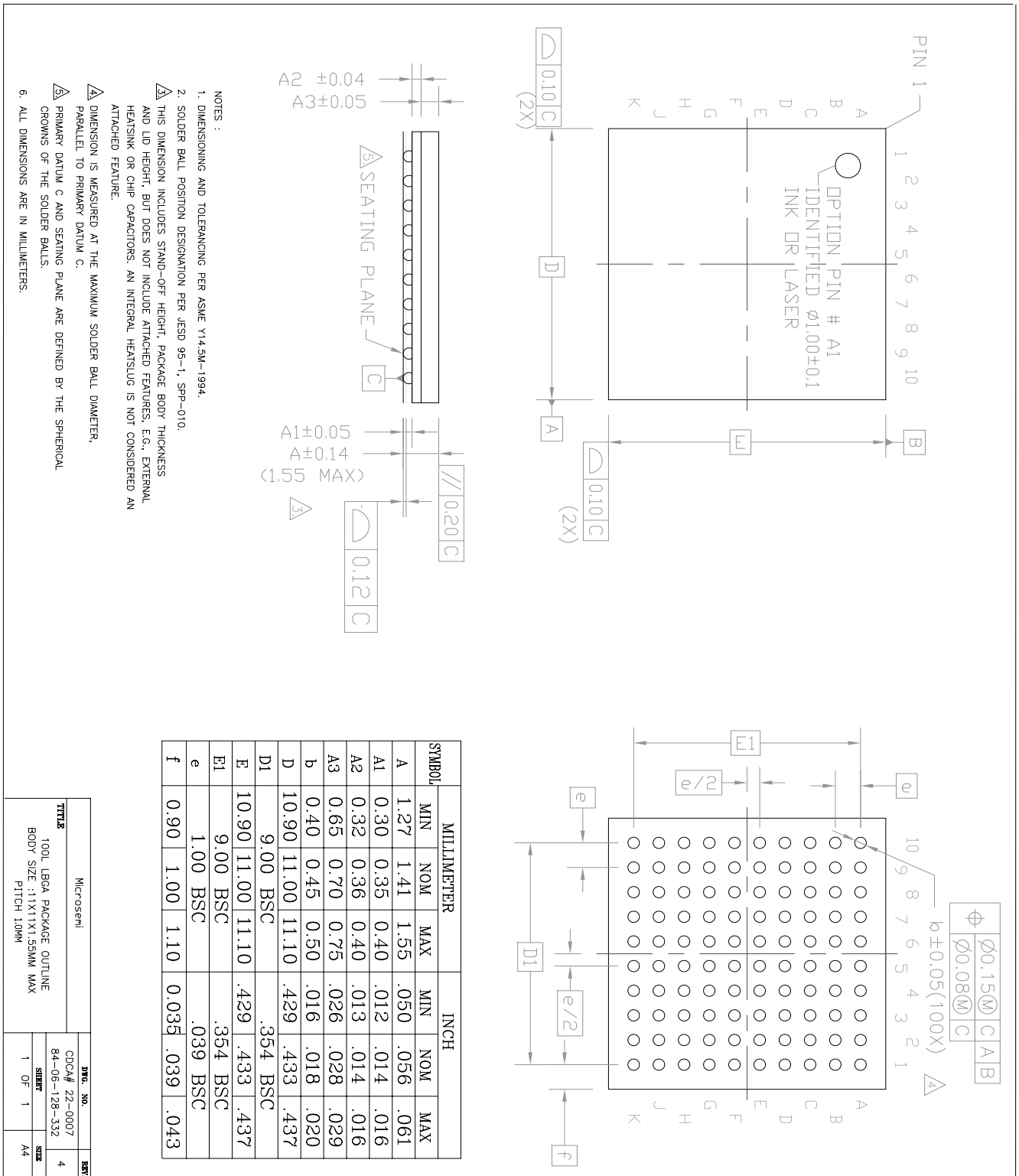


Figure 1 - Functional Block Diagram

Mechanical Drawing



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